Preliminary bq2145

Smart Battery Module with LEDs

Features

► Complete smart battery solution for NiCd, NiMH, and Li-Ion battery packs

NITRODE

- ▶ Based on the bq2945 Gas Gauge IC
- > Accurate measurement of available battery capacity
- Designed for battery pack integration:
 - Measures only 2.5 (L) x 0.7 (W) inches
 - Includes Gas Gauge IC, configuration EEPROM, and sense resistor
 - $% \left({{\rm Five}}\right)$ onboard state-of-charge LEDs with push-button activation
 - Low operating current for minimal battery drain
- Critical battery information available over two-wire serial port

General Description

The bq2145 Smart Battery Module provides a complete solution for the design of intelligent battery packs. The bq2145 uses the SMBus protocol and supports Smart Battery Data commands in the SMB/SBD specifications. Designed for battery pack integration, the bq2145 combines the bq2945 Gas Gauge IC with a serial EEPROM on a small printed circuit board. The board includes all the necessary components to accurately monitor battery capacity and communicate critical battery parameters to the host system or battery charger. The bq2145 also includes five LEDs. The push-button switch activates the LEDs to show remaining battery capacity in 20% increments.

Contacts are provided on the bq2145 for direct connection to the battery stack (B+, B-) and the two-wire interface (C, D). Please refer to the bq2945 data sheet for specific information on the operation of the Gas Gauge and communication interface.

Unitrode configures the bq2145 based on the information requested in Table 1. The configuration defines the pack voltage, capacity, and chemistry and charge control parameters. The Smart Battery Module uses the onboard sense resistor to track charge and discharge activity of the battery pack. Figure 1 shows how the module connects to the cells.



A module development kit is also available for the bq2145. The bq2145B-KT or the bq2145LB-KT includes one configured module and the following:

- 1) An EV2200-45 interface board that allows connection to the serial port of any AT-compatible computer.
- 2) Menu-driven software to display charge/discharge activity and to allow user interface to the Gas Gauge IC and serial E^2 PROM from any standard Windows 95 or 3.1x PC.

Pin Descriptions

- B+ BAT+/Battery positive/Pack positive
- P- PACK-/Pack negative
- C SMBC/Communications clock
- D SMBD/Serial data
- B- BAT-/Battery negative
- CP2 Control pin 2
- CP1 Control pin 1

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Figure 1. Module Connection Diagram

Customer Name:				
Contact:				
Address:				
Sales Contact:				
Board Configuration				
LEDs and switch		Yes or No		
Display mode		Relative or Absolute		
Discharge rate (3.0A max.)	Min	Avg Max		
Duration at max. discharge				
Number of series cells				
EEPROM Configuration				l Values
			NiMH	Li-Ion
			10 min	10 min
Remaining capacity alarm _ (mAh)		Sets the low capacity alarm level	C/10	C/10
Charging voltage (mV)		Sets the requested charging voltage	65535	4.1V/cell
Design cpaacity (mAh)		Defines the battery pack capacity	3000	3600
Design voltage (mV)		Defines the battery pack voltage	12000	10800
Manufacturer date		Battery pack manufacturer date	mm/dd/yy	mm/dd/yy
Serial number		Battery pack serial number	0-65535	0-65535
Fast-charging current (mA)		Sets the requested charging current	1C	1C
Maintenance charging current (mA)		Sets the requested maintenance charging current	C/20	0
Li-Ion taper current (mA)		Sets the upper limit for charge termination	NA	C/10
Maximum overcharge (mAh)		Sets the maximum amount of overcharge	256 mAh	128mAh
Maximum temperature (°C)		Sets the maximum charge temperature	$61^{\circ}\mathrm{C}$	$61^{\circ}\mathrm{C}$
$\Delta T/\Delta t$ (°C/min)		Sets the termination rate	3°C/3min	$4.6^{\circ}C/20s$
Fast-charge efficiency (%)		Sets the fast-charge efficiency factor	95%	100%
Maintenance charge effi- ciency (%)		Sets the maintence charge efficiency factor	80%	100%
Self-discharge rate (%/day)		Sets the batterys self-discharge rate	1.5%/day	0.2%/day
EDV1 (mV)		Sets the initial end-of-discharge warning	1.05V/cell	3.0V/cell
EDVF (mV)		Sets the final end-of-discharge warning	1.0V/cell	2.8V/cell
Hold-off timer for $\Delta T/\Delta t$ (sec.) _		Sets the hold off period for $\Delta T/\Delta t$ termination	180s	320s
Manufacturer name _		Programs manufacturer's name (11 char. max)	bq	bq
Device name		Programs device name (7 char. max)	bq36	bq202
Chemistry _		Programs pack's chemistry (7 char. max)	NiMH	LION
Manufacturer data		Open field (5 char. max)	2040	2040
FAE Approval			Date:	

Table 1. bq2145 Module Configuration

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bq2145 Schematic



bq2145 Board



Ordering Information





2. Example production part number: bq2145LB-001

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